

# TinyLogic UHS Two-Input NAND Gate

## NC7SZ00

### Description

The NC7SZ00 is a single two-input NAND gate from onsemi's Ultra-High Speed (UHS) series of TinyLogic. The device is fabricated with advanced CMOS technology to achieve ultra-high speed with high output drive while maintaining low static power dissipation over a broad  $V_{CC}$  operating range. The device is specified to operate over the 1.65 V to 5.5 V  $V_{CC}$  operating range. The inputs and output are high impedance when  $V_{CC}$  is 0 V. Inputs tolerate voltages up to 5.5 V, independent of  $V_{CC}$  operating voltage.

### Features

- Ultra-High Speed:  $t_{PD} = 2.4$  ns (Typical) into 50 pF at 5 V  $V_{CC}$
- High Output Drive:  $\pm 24$  mA at 3 V  $V_{CC}$
- Broad  $V_{CC}$  Operating Range: 1.65 V to 5.5 V
- Matches Performance of LCX Operated at 3.3 V  $V_{CC}$
- Power Down High-Impedance Inputs / Outputs
- Over-Voltage Tolerance Inputs Facilitate 5 V to 3 V Translation
- Proprietary Noise / EMI Reduction Circuitry
- Ultra-Small MicroPak™ Packages
- Space-Saving SOT23-5, SC-74A and SC-88A Packages
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

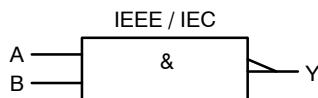
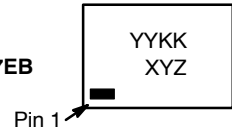


Figure 1. Logic Symbol

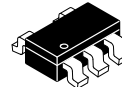
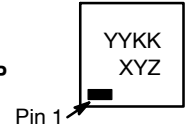
### MARKING DIAGRAMS



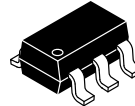
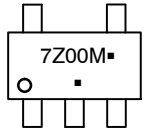
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CASE 127EB



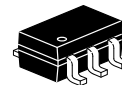
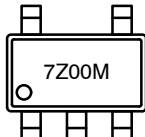
UDFN6  
CASE 517DP



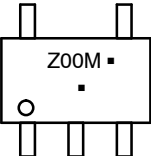
SC-74A  
CASE 318BQ



SOT23-5  
CASE 527AH



SC-88A  
CASE 419A-02



YY, 7Z00, Z00 = Specific Device Code  
 KK = 2-Digit Lot Run Traceability Code  
 XY = 2-Digit Date Code Format  
 Z = Assembly Plant Code  
 M = Data Code  
 ■ = Pb-Free Package

(Note: Microdot may be in either location)

### ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 6 of this data sheet.

NOTE: Some of the devices on this data sheet have been **DISCONTINUED**. Please refer to the table on page 6.

# NC7SZ00

## Pin Configurations

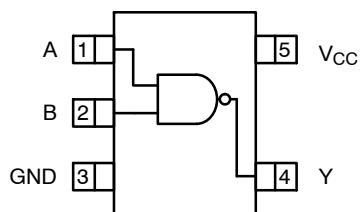


Figure 2. SOT23-5, SC-88A and SC-74A (Top View)

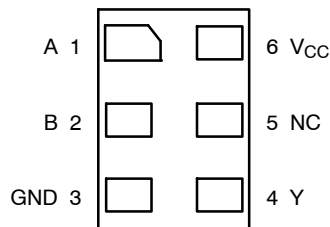


Figure 3. MicroPak (Top Through View)

### PIN DEFINITIONS

Pin # SOT23-5, SC-88A / SC74A	Pin # MicroPak	Name	Description
1	1	A	Input
2	2	B	Input
3	3	GND	Ground
4	4	Y	Output
5	6	V <sub>CC</sub>	Supply Voltage
	5	NC	No Connect

### FUNCTION TABLE

Inputs		Output
A	B	Y
L	L	H
L	H	H
H	L	H
H	H	L

H = HIGH Logic Level  
L = LOW Logic Level

### ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Min	Max	Unit	
V <sub>CC</sub>	Supply Voltage	-0.5	6.5	V	
V <sub>IN</sub>	DC Input Voltage	-0.5	6.5	V	
V <sub>OUT</sub>	DC Output Voltage	-0.5	6.5	V	
I <sub>IK</sub>	DC Input Diode Current				
	V <sub>IN</sub> < 0 V	-	-50	mA	
I <sub>OK</sub>	DC Output Diode Current				
	V <sub>OUT</sub> < 0 V	-	-50	mA	
I <sub>OUT</sub>	DC Output Current	-	±50	mA	
I <sub>CC</sub> or I <sub>GND</sub>	DC V <sub>CC</sub> or Ground Current	-	±50	mA	
T <sub>STG</sub>	Storage Temperature Range	-65	+150	°C	
T <sub>J</sub>	Junction Temperature Under Bias	-	+150	°C	
T <sub>L</sub>	Junction Lead Temperature (Soldering, 10 Seconds)	-	+260	°C	
P <sub>D</sub>	Power Dissipation in Still Air	SC-74A / SOT23-5	-	390	mW
		SC-88A	-	332	
		MicroPak-6	-	812	
		MicroPak2™-6	-	812	
ESD	Human Body Model, JEDEC: JESD22-A114	-	2000	V	
	Charge Device Model, JEDEC: JESD22-C101	-	1000		

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

### RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	Supply Voltage Operating		1.65	5.5	V
	Supply Voltage Data Retention		1.5	5.5	

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## RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>IN</sub>	Input Voltage		0	5.5	V
V <sub>OUT</sub>	Output Voltage		0	V <sub>CC</sub>	V
T <sub>A</sub>	Operating Temperature		-40	+85	°C
t <sub>r</sub> , t <sub>f</sub>	Input Rise and Fall Times	V <sub>CC</sub> = 1.8 V, 2.5 V ±0.2 V	0	20	ns/V
		V <sub>CC</sub> = 3.3 V ±0.3 V	0	10	
		V <sub>CC</sub> = 5.0 V ±0.5 V	0	5	
θ <sub>JA</sub>	Thermal Resistance	SC-74A / SOT23-5	-	320	°C/W
		SC-88A	-	377	
		MicroPak-6	-	154	
		MicroPak2-6	-	154	

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

1. Unused inputs must be held HIGH or LOW. They may not float.

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## DC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	V <sub>CC</sub> (V)	Conditions	T <sub>A</sub> = +25°C			T <sub>A</sub> = -40 to +85°C		Unit	
				Min	Typ	Max	Min	Max		
V <sub>IH</sub>	HIGH Level Input Voltage	1.65 to 1.95		0.65 V <sub>CC</sub>	-	-	0.65 V <sub>CC</sub>	-	V	
		2.30 to 5.50		0.70 V <sub>CC</sub>	-	-	0.70 V <sub>CC</sub>	-		
V <sub>IL</sub>	LOW Level Input Voltage	1.65 to 1.95		-	-	0.35 V <sub>CC</sub>	-	0.35 V <sub>CC</sub>	V	
		2.30 to 5.50		-	-	0.30 V <sub>CC</sub>	-	0.30 V <sub>CC</sub>		
V <sub>OH</sub>	HIGH Level Output Voltage	1.65	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> , I <sub>OH</sub> = -100 μA	1.55	1.65	-	1.55	-	V	
		1.80		1.70	1.80	-	1.70	-		
		2.30		2.20	2.30	-	2.20	-		
		3.00		2.90	3.00	-	2.90	-		
		4.50		4.40	4.50	-	4.40	-		
		1.65	I <sub>OH</sub> = -4 mA	1.29	1.52	-	1.29	-		
		2.30		I <sub>OH</sub> = -8 mA	1.90	2.15	-	1.90		-
		3.00		I <sub>OH</sub> = -16 mA	2.40	2.80	-	2.40		-
		3.00		I <sub>OH</sub> = -24 mA	2.30	2.68	-	2.30		-
		4.50		I <sub>OH</sub> = -32 mA	3.80	4.20	-	3.80		-
V <sub>OL</sub>	LOW Level Output Voltage	1.65	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> , I <sub>OL</sub> = 100 μA	-	0.00	0.10	-	0.08	V	
		2.30		-	0.00	0.10	-	0.10		
		3.00		-	0.00	0.10	-	0.10		
		3.00		-	0.00	0.10	-	0.10		
		4.50		-	0.00	0.10	-	0.10		
		1.65	I <sub>OL</sub> = 4 mA	-	0.80	0.24	-	0.24		
		2.30		I <sub>OL</sub> = 8 mA	-	0.10	0.30	-		0.30
		3.00		I <sub>OL</sub> = 16 mA	-	0.15	0.40	-		0.40
		3.00		I <sub>OL</sub> = 24 mA	-	0.22	0.55	-		0.55
		4.50		I <sub>OL</sub> = 32 mA	-	0.22	0.55	-		0.55
I <sub>IN</sub>	Input Leakage Current	1.65 to 5.5	V <sub>IN</sub> = 5.5 V, GND	-	-	±1	-	±10	μA	
I <sub>OFF</sub>	Power Off Leakage Current	0	V <sub>IN</sub> or V <sub>OUT</sub> = 5.5 V	-	-	1	-	10	μA	
I <sub>CC</sub>	Quiescent Supply Current	1.65 to 5.5	V <sub>IN</sub> = 5.5 V, GND	-	-	2	-	20	μA	

AC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	V <sub>CC</sub> (V)	Conditions	T <sub>A</sub> = +25°C			T <sub>A</sub> = -40 to +85°C		Unit
				Min	Typ	Max	Min	Max	
t <sub>PHL</sub> , t <sub>PLH</sub>	Propagation Delay (Figure 4, 5)	1.65	C <sub>L</sub> = 15 pF, R <sub>L</sub> = 1 MΩ	-	5.4	11.4	-	12.0	ns
		1.80		-	4.5	9.5	-	10.0	
		2.50 ±0.20		-	3.0	6.5	-	7.0	
		3.30 ±0.30		-	2.4	4.5	-	4.7	
		5.00 ±0.50		-	2.0	3.9	-	4.1	
		3.30 ±0.30		C <sub>L</sub> = 50 pF, R <sub>L</sub> = 500 Ω	-	2.9	5.0	-	
		5.00 ±0.50	-		2.4	4.3	-	4.5	
C <sub>IN</sub>	Input Capacitance	0.00		-	4	-	-	-	pF
C <sub>PD</sub>	Power Dissipation Capacitance (Note 2) (Figure 6)	3.30		-	24	-	-	-	pF
		5.00		-	30	-	-	-	

2. C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I<sub>CCD</sub>) at no output loading and operating at 50% duty cycle. C<sub>PD</sub> is related to I<sub>CCD</sub> dynamic operating current by the expression:  
 $I_{CCD} = (C_{PD}) (V_{CC}) (f_{IN}) + (I_{CC}static)$ .

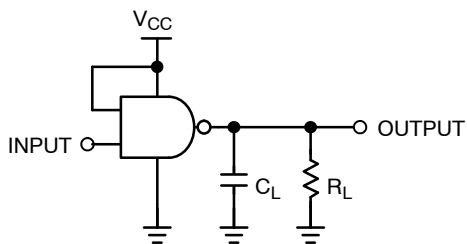


Figure 4. AC Test Circuit

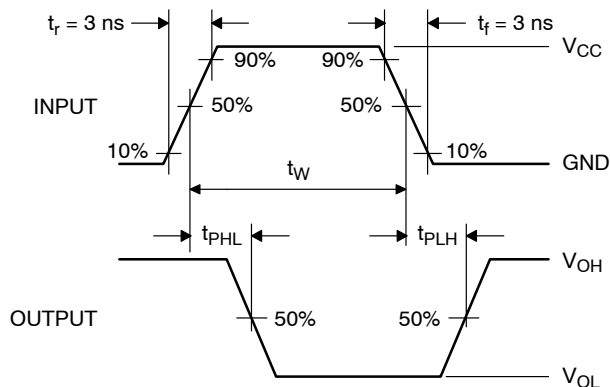
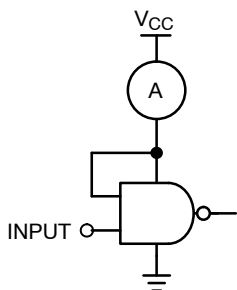


Figure 5. AC Waveforms



NOTE:

3. Input = AC Waveform; t<sub>r</sub> = t<sub>f</sub> = 1.8 ns;  
 PRR = 10 MHz; Duty Cycle = 50%.

Figure 6. I<sub>CCD</sub> Test Circuit

# NC7SZ00

## ORDERING INFORMATION

Part Number	Top Mark	Package	Shipping <sup>†</sup>
NC7SZ00M5X	7Z00	SC-74A	3000 / Tape & Reel
NC7SZ00P5X	Z00	SC-88A	3000 / Tape & Reel
NC7SZ00L6X	YY	SIP6, MicroPak	5000 / Tape & Reel
NC7SZ00FHX	YY	UDFN6, MicroPak2	5000 / Tape & Reel

### DISCONTINUED (Note 4)

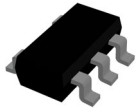
NC7SZ00M5X-L22090	7Z00	SOT23-5	3000 / Tape & Reel
NC7SZ00L6X-L22175	YY	SIP6, MicroPak	5000 / Tape & Reel
NC7SZ00FHX-L22175	YY	UDFN6, MicroPak2	5000 / Tape & Reel

<sup>†</sup> For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

4. **DISCONTINUED:** These devices are not available. Please contact your **onsemi** representative for information. The most current information on these devices may be available on [www.onsemi.com](http://www.onsemi.com).

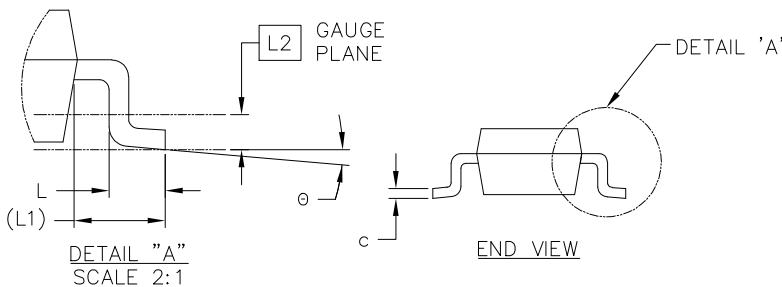
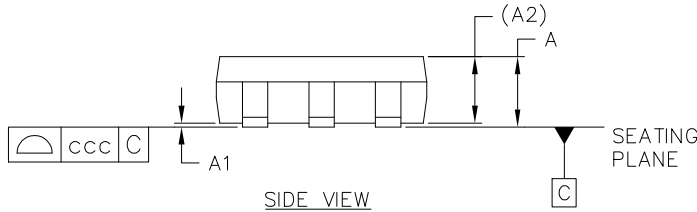
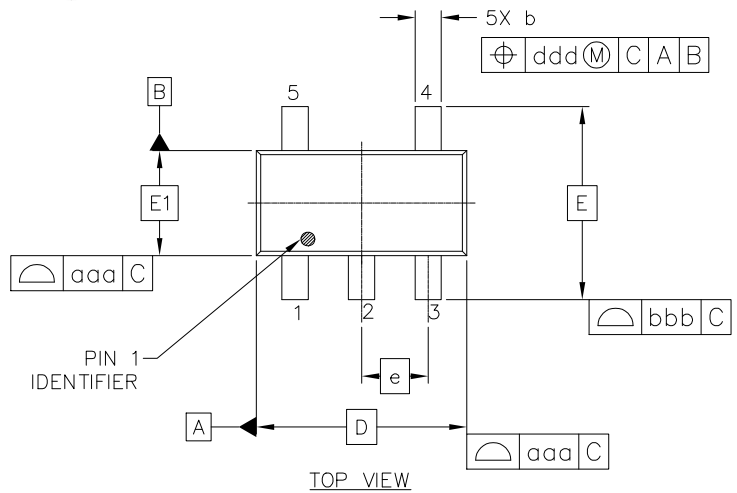
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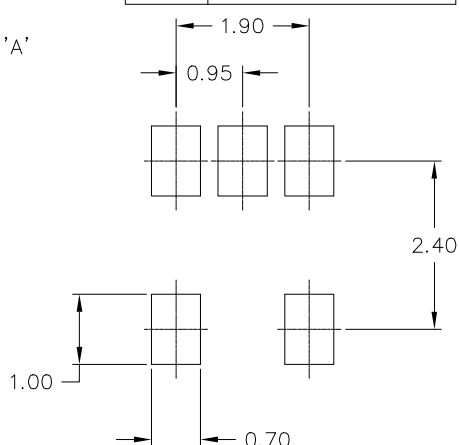


SC-74A-5 3.00x1.50x0.95, 0.95P  
CASE 318BQ  
ISSUE D

DATE 13 APR 2026

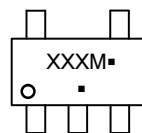


MILLIMETERS			
DIM	MIN	NOM	MAX
A	0.90	1.00	1.10
A1	0.01	0.05	0.10
A2	0.95 REF		
b	0.25	0.37	0.50
c	0.10	0.18	0.26
D	3.00 BSC		
E	2.75 BSC		
E1	1.50 BSC		
e	0.95 BSC		
L	0.20	0.40	0.60
L1	0.60 REF		
L2	0.25 BSC		
θ	0°	5°	10°
TOLERANCE FORM AND POSITION			
aaa	0.15		
bbb	0.15		
ccc	0.05		
ddd	0.20		



- NOTES:
1. DIMENSIONING AND TOLERANCING AS PER ASME Y14.5M, 2018.
  2. CONTROLLING DIMENSION: MILLIMETERS.
  3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
  4. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.15mm PER SIDE.

GENERIC MARKING DIAGRAM\*



- XXX = Specific Device Code
- M = Date Code
- = Pb-Free Package

(Note: Microdot may be in either location)

RECOMMENDED MOUNTING FOOTPRINT  
\*For additional information in our Pb-Free Strategy and Soldering details, Please download the onsemi Soldering and Mounting Techniques Reference manual. SOLDERRM/D.

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

DOCUMENT NUMBER:	98AON66279G	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.
DESCRIPTION:	SC-74A-5 3.00x1.50x0.95, 0.95P	PAGE 1 OF 1

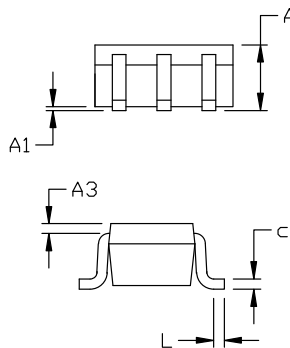
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SCALE 2:1

SC-88A (SC-70-5/SOT-353)  
CASE 419A-02  
ISSUE M

DATE 11 APR 2023



RECOMMENDED MOUNTING FOOTPRINT

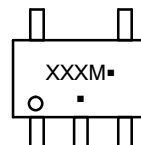
\* For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERM/D.

NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETERS
3. 419A-01 OBSOLETE. NEW STANDARD 419A-02
4. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.1016MM PER SIDE.

DIM	MILLIMETERS		
	MIN.	NOM.	MAX.
A	0.80	0.95	1.10
A1	---	---	0.10
A3	0.20 REF		
b	0.10	0.20	0.30
c	0.10	---	0.25
D	1.80	2.00	2.20
E	2.00	2.10	2.20
E1	1.15	1.25	1.35
e	0.65 BSC		
L	0.10	0.15	0.30

GENERIC MARKING DIAGRAM\*



\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

XXX = Specific Device Code  
M = Date Code  
▪ = Pb-Free Package

(Note: Microdot may be in either location)

STYLE 1:

- PIN 1. BASE
- EMITTER
- BASE
- COLLECTOR
- COLLECTOR

STYLE 2:

- PIN 1. ANODE
- EMITTER
- BASE
- COLLECTOR
- CATHODE

STYLE 3:

- PIN 1. ANODE 1
- N/C
- ANODE 2
- CATHODE 2
- CATHODE 1

STYLE 4:

- PIN 1. SOURCE 1
- DRAIN 1/2
- SOURCE 1
- GATE 1
- GATE 2

STYLE 5:

- PIN 1. CATHODE
- COMMON ANODE
- CATHODE 2
- CATHODE 3
- CATHODE 4

STYLE 6:

- PIN 1. EMITTER 2
- BASE 2
- EMITTER 1
- COLLECTOR
- COLLECTOR 2/BASE 1

STYLE 7:

- PIN 1. BASE
- EMITTER
- BASE
- COLLECTOR
- COLLECTOR

STYLE 8:

- PIN 1. CATHODE
- COLLECTOR
- N/C
- BASE
- EMITTER

STYLE 9:

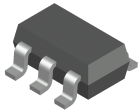
- PIN 1. ANODE
- CATHODE
- ANODE
- ANODE
- ANODE

Note: Please refer to datasheet for style callout. If style type is not called out in the datasheet refer to the device datasheet pinout or pin assignment.

DOCUMENT NUMBER:	98ASB42984B	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.
DESCRIPTION:	SC-88A (SC-70-5/SOT-353)	PAGE 1 OF 1

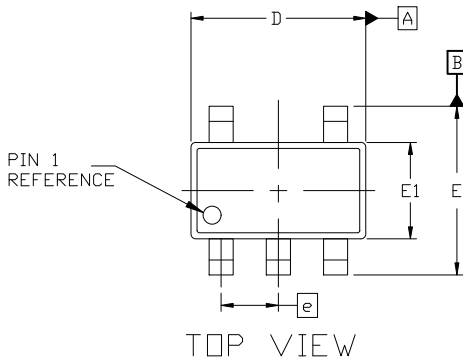
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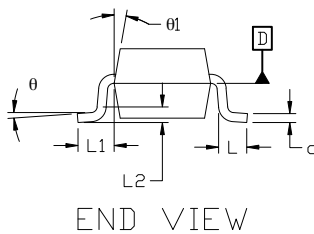
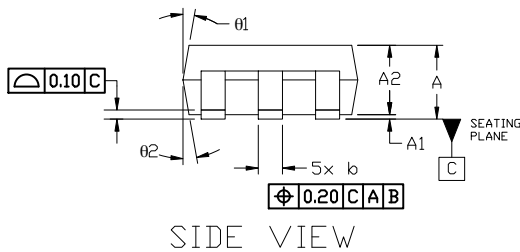
**SOT-23, 5 Lead  
CASE 527AH  
ISSUE A**

DATE 09 JUN 2021



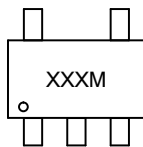
NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 19894
2. CONTROLLING DIMENSION: MILLIMETERS
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE BASE MATERIAL.
4. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.25 PER SIDE. D AND E1 DIMENSIONS ARE DETERMINED AT DATUM D.
5. DIMENSION 'b' DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08mm TOTAL IN EXCESS OF THE 'b' DIMENSION AT MAXIMUM MATERIAL CONDITION. MINIMUM SPACE BETWEEN PROTRUSION AND AN ADJACENT LEAD SHALL NOT BE LESS THAN 0.07mm.



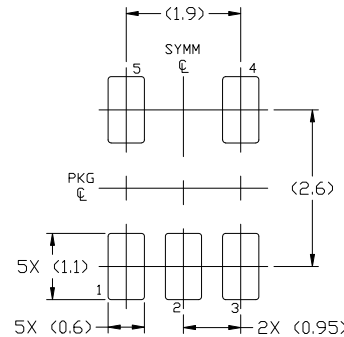
DIM	MILLIMETERS		
	MIN.	NOM.	MAX.
A	0.90	—	1.45
A1	0.00	—	0.15
A2	0.90	1.15	1.30
b	0.30	—	0.50
c	0.08	—	0.22
D	2.90 BSC		
E	2.80 BSC		
E1	1.60 BSC		
e	0.95 BSC		
L	0.30	0.45	0.60
L1	0.60 REF		
L2	0.25 REF		
theta	0°	4°	8°
theta1	0°	10°	15°
theta2	0°	10°	15°

**GENERIC MARKING DIAGRAM\***



XXX = Specific Device Code  
M = Date Code

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.



**RECOMMENDED MOUNTING FOOTPRINT**  
For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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<b>DESCRIPTION:</b>	<b>SOT-23, 5 LEAD</b>	<b>PAGE 1 OF 1</b>

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